

4CX250B

Radial-Beam Power Tetrode



The Penta 4CX250B is a forced-air cooled, 250-watt plate dissipation, external anode, ceramic and metal radial beam tetrode. The superior construction of the 4CX250B makes it ideal for use as a grid driven RF amplifier or oscillator, or an AF power amplifier or modulator.

ELECTRICAL CHARACTERISTICS

Cathode - - Unipotential Oxide Coated

Heater:

Voltage6.	0 ±0.30	Volts
Current	2.6	Amperes
Maximum Cathode-Heater Potential	±150	Volts
Amplification Factor	5	
Interelectrode Capacitances Grounded Grid and Screen		
Feedback	0.01	pF
Input	13	pF
Output	4.5	pF
Interelectrode Capacitances Grounded Cathode		
Feedback	0.04	pF
Input	15.7	pF
Output	4.5	pF
Frequency of Maximum Rating	500	MHz

MECHANICAL CHARACTERISTICS

Base J	EDEC B8-236
Maximum Overall Dimensions	
Length	2.46 Inches
Diameter	1.65 Inches
Net Weight	4.0 Onces
Mounting Position	Any
Maximum Seal and Anode Temperature	250°C
Cooling	Forced Air
Recommended Socket and Chimney	PL600/PL606
Required Air Flow at Maximum Dissipation	6.5 CFM

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PENTA LABORATORIES

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COOLING

Forced air cooling of the base, base seals, and other external tube surfaces is required for all classes of operation. The use of the PL600 socket and the PL606 chimney, in conjunction with a blower capable of sustaining the required air flow is highly recommended. It should be noted that maintaining surface temperatures below the maximum values will substantially prolong the useful life of the tube.

The air flow required to sustain the tube surface temperature at 200°C (at sea level and for operation where ambient air temperature does not exceed 50°C) is listed below.

Dissipation Air Flow Pressure Drop 200 Watts5.0 CFM0.52 In./H₂O 250 Watts6.5 CFM0.87 In./H₂O

It is necessary to keep in mind that high altitude operation, or operation where ambient air temperatures exceed 50°C will require addition air flow to maintain the desired tube surface temperature.

Useful life can be extended by maintaining the flow of cooling air to the tube during standby periods (i.e., those periods when only heater voltage is applied.) Care should be taken to insure that the anode surface and cooling fins remain free from any dirt or debris which might interfere with the effective cooling of the tube.

VIBRATION

The rugged construction of the 4CX250B makes it an ideal choice for use in environments where a moderate degree of shock and vibration are likely to be encountered. Such applications include truck and automobile mobile units and other similar classes of service. In those situations where extreme shock and vibration are anticipated, the ruggedized version of this tube, the Penta 4CX250R is highly recommended.

PLATE DISSIPATION

Under all classes of operation, the maximum plate dissipation allowable for the 4CX250B is 250 watts; however, in plate modulated applications, this maximum must be limited to 165 watts. During tuning, plate dissipation may be permitted to rise above the stated maximums for brief periods of time.

SCREEN-GRID OPERATION

Under no conditions should the screen dissipation be allowed to exceed 12 watts. In that excessive screen dissipation is likely to result where plate voltage, plate load, or bias voltage are removed, suitable precautions should be taken to avoid these conditions while filament and screen voltages are applied.

CONTROL GRID OPERATION

The 4CX250B has a maximum control grid dissipation rating of 2.0 watts and a maximum grid dissipation rating of -250 dc volts; failure to respect these maximums will result in damage to the tube. Tube life can be extended by maintaining grid bias and driving power within the recommended value ranges whenever possible. The maximum grid circuit resistance is 100,000 ohms per tube.

HEATER VOLTAGE

The 4CX250B is designed to operate with 6.0 volts applied to the heater. Under no circumstances should filament voltage be allowed to exceed this value by more than 5%. The useful life of the tube can be extended by adhering to this value as closely as possible.

At frequencies exceeding 300 MHz, cathode temperature begins to be influenced by transit time effects. Under such conditions, the exact amount of driving power which is diverted to heating the cathode is difficult to estimate and is affected by a variety of factors (frequency, driving power, plate current, etc.) When the tube is subjected to maximum input, 0.05 volts should be deducted from the heater voltage for every 20MHz by which the tube exceeds 300 MHz (at 400MHz, 400-300=100, 100/20=5, 5x0.05=.25, 6.0-.25=5.75, thus heater voltage should be limited to 5.75 volts.)

MULTIPLE AND VHF OPERATION

When a pair of 4CX250B tubes operated under parallel or push-pull conditions, it is imperative that the load be shared equally by both tubes. Overload protection should be designed in such a way so as to protect either tube in the event that a single tube should fail.

When the 4CX250B is operated in the VHF region, it may be desirable to achieve an increase in tube life at the expense of operating efficiency. Minimum bias, heavy plate loading, and as low degree of driving power as is practical should be employed.

MAXIMUM RATINGS AND TYPICAL OPERATING CONDITIONS

RF Power Amplifier or Oscillator--Class C Telegraphy

Maximum Ratings DC Plate Voltage Screen Voltage DC Grid Voltage Plate Current Plate Dissipation Screen Dissipation Grid Dissipation			 	30 OC -25 0.2 25 . 12	0 Vc 50 Vc 25 An 0 Wa	olts olts olts opere atts atts
Typical Operation	Freq	uencies	to 175	MHz	500	MHz
DC Plate Voltage	500	1000	1500	2000	2000	Volts
DC Screen Voltage	250	250	250	250	300	Volts
DC Grid Voltage	-90	-90	-90	-90	-90	Volts
DC Plate Current	250	250	250	250	250	mΑ
DC Screen Current	45	38	21	19	10	mΑ
DC Grid Current	35	31	28	26	10	mΑ
Peak RF Grid Voltage	114	114	112	112		Volts
Driving Power	4.0	3.5	3.2	2.9		Watts
Plate Input PowerPlate	125	250	375	500	500	Watts
Output Power Heater	70	190	280	390	290	Watts
Voltage	6.0	6.0	6.0	6.0	5.5	Volts

Plate Modulated RF Power Amplifier--Class C Telephony (Amplifier-Grid Driven)

Maximum Ratings			1500	Volts
DC Plate Voltage		DC	300	Volts
Screen Voltage			-250	Volts
DC Grid Voltage		DC	0.20	Ampere
Plate Current			165	Watts
Plate Dissipation			12.0	Watts
Screen Dissipation			2.0	Watts
Grid Dissipation				
Typical Operation				
DC Plate Voltage	500	1000	1500	Volts
DC Screen Voltage	250	250	250	Volts
DC Grid Voltage	-100	-100	-100	Volts
DC Plate Current	200	200	200	mA
DC Screen Current	31	22	20	mA
DC Grid Current	15	14	14	mA
Peak RF Grid Voltage	118	117	117	Volts
Driving Power	1.8	1.7	1.7	Watts
Plate Input PowerPlate	100	200	300	Watts
Output Power	60	145	235	Watts



AF Amplifier or ModulatorClass AB ₁ Maximum Ratings (Per Tube)				
DC Plate Voltage DC Screen Voltage DC Grid Voltage			2000 400	Volts Volts
DC Plate Current			-250 0.25	Volts Ampere
Plate Dissipation			250	Watts
Screen Dissipation			12.0	Watts
Grid Dissipation			2.0	Watts
Typical Operation (Two Tubes)				
DC Plate Voltage	1000	1500	2000	Volts
DC Screen Voltage	350	350	350	Volts
DC Grid Voltage (1/3)	-55	-55		Volts
Zero-Signal DC Plate Current	200	200		mA
Maximum Signal DC Plate Current	500	500		mA
Maximum Signal DC Screen Current	20	16		mA mA
Peak AF Grid Voltage	0 50	0 50	_	Volts
Peak Driving Power	0	0		Watts
Plate Input Power	_	750		Watts
Output Power	240	430		Watts
Plate to Plate Load Resistance	3500	6200	9500	Ω
RF Linear AmplifierClass AB ₁ (SSB or Carrier Conditions) Maximum Ratings				
DC Plate Voltage		DC	2000	Volts
Screen Voltage			400	Volts
DC Grid Voltage			-250	Volts
Plate Current			0.25	Ampere
Plate Dissipation			250	Watts
Screen Dissipation			12.0 2.0	Watts Watts
Ond Dissipation			2.0	vvallo
Typical Operation				
DC Plate Voltage	1000	1500	2000	Volts
DC Screen Voltage	350	350	350	Volts
DC Grid Voltage	-55	-55		Volts
Zero-Signal DC Plate Current	100	100	100	mA
Single Tone DC Plate Current	250	250	250	mA
Two-Tone DC Plate Current	190	190	190	mA
Single Tone DC Screen Current	10	8	5	mA
Two-Tone DC Screen Current	2.0	-1.0	-2.0	mA
Single Tone DC Grid Current	0	0	0	mA
Peak RF Grid Voltage	50	50	50	Volts
Plate Output Power	120	215		Watts
Resonant Load Impedance Carrier Conditions		3000	4000	Ω
	2000	3000	1000	22
Carrier DC Plate Current				
Carrier DC Plate Current	150	150	150	mA
Carrier DC Plate Current Carrier DC Screen Current Peak RF Grid Voltage Plate	150 -3		150 -4	
Carrier DC Screen Current	150 -3	150 -4	150 -4 25	mA mA

2500

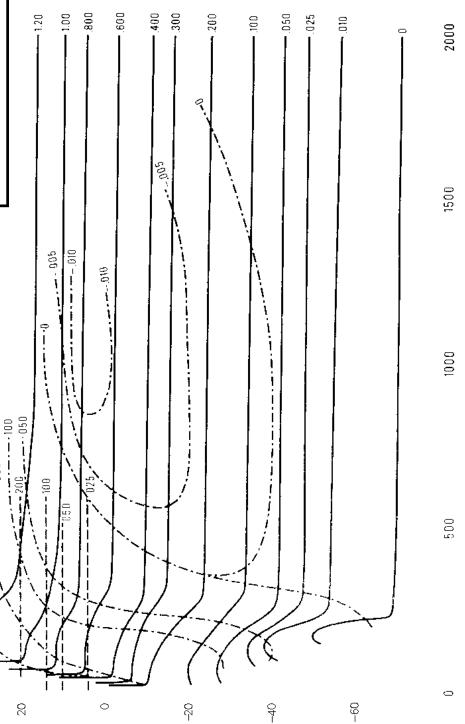
PLATE VOLTAGE (V)

CONSTANT CURRENT CHARACTERISTICS SCREEN VOLTAGE = 250V

- PLATE CURRENT - AMPERES ----- SCREEN CURRENT - AMPERES AMPERES GRID CURRENT

4-400

4



GRID VOLTAGE (V)

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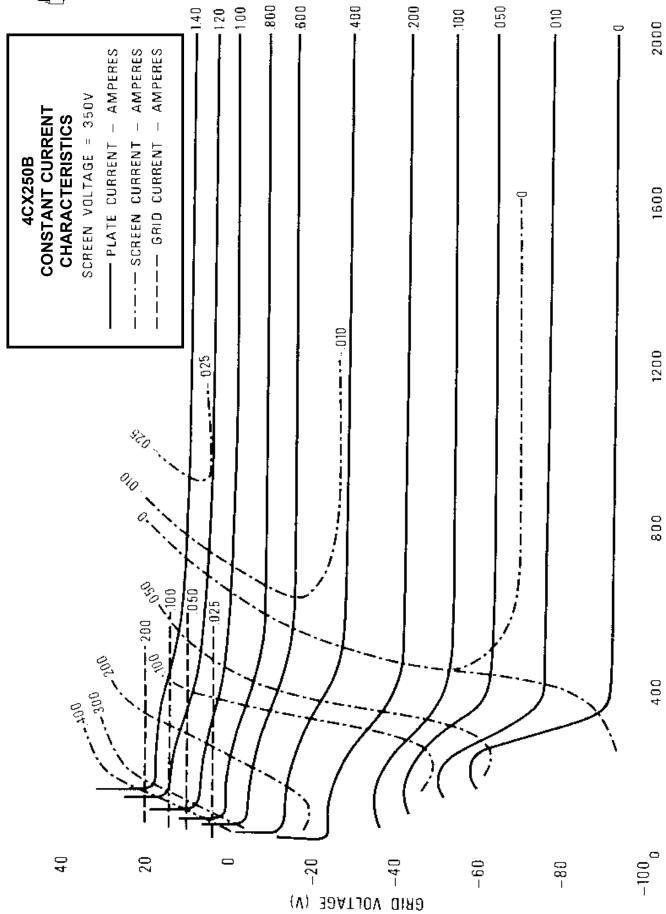


PLATE VOLTAGE (V)

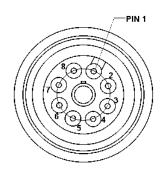
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PIN DESIGNATION

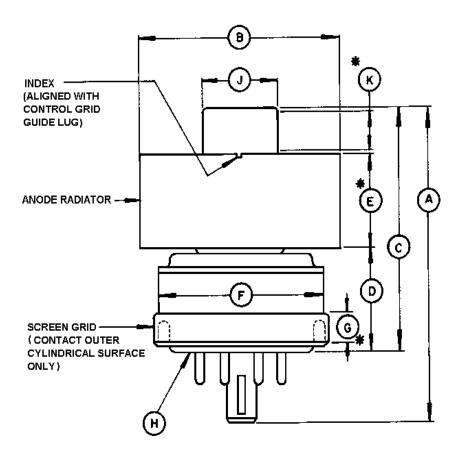
PIN NO. 1 SCREEN GRID
PIN NO. 2 CATHODE
PIN NO. 3 HEATER
PIN NO. 4 CATHODE

PIN NO. 5 I.C. DO NOT USE FOR EXTERNAL CONNECTION

PIN NO. 6 CATHODE
PIN NO. 7 HEATER
PIN NO. 8 CATHODE
CENTER PIN - CONTROL GRID



DIMENSIONAL DATA						
DIM. IN		HES	MILLIMETERS			
DIN.	MIN.	MAX.	MIN.	MAX.		
A	2.342	2.464	59.03	62.59		
В	1.610	1.640	40.69	41.66		
Ç	1.810	1.910	45.97	48.51		
D	0.750	0.810	19.05	20.57		
E	0.710	0.790	18.03	20.07		
F	-	1.406		35.71		
G	0.187	-	4.75	-		
н	BASE: B8-236 (JEDEC DESIGNATION)					
J	0.559	0.573	14.20	14.55		
ĸ	0.240		6.10			



NOTES:

- REF DIMS, ARE FOR INFO. ONLY AND ARE NOT REQD. FOR INSPECTION PURPOSES.
- 2. (*) CONTACT SURPACES.